HCNS0804

80V N-Channel MOSFET

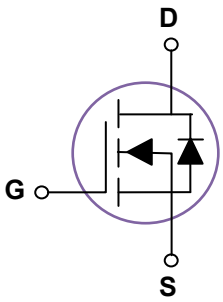
General Description

These N-Channel enhancement mode power field effect transistors are using SGT technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

V_{DS}	80V
I_D (at V_{GS}=10V)	100A
$R_{DS(ON)}$ (at V_{GS}=10V)	2.8mΩ(Typ)

PDFN5x6



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	80	V
Gate-Source Voltage		V_{GS}	±20	V
Drain Current-Continuous	TC=25°C	I_D	100	A
	TC=100°C	I_D	63	A
Maximum Power Dissipation		P_D	142	W
Single pulse avalanche energy(1)		E_{AS}	540	mJ
Junction and Storage Temperature Range		T_J,T_{STG}	-55 To 150	℃

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance junction-case	$R_{\theta Jc}$		1.1	℃ /W
Thermal Resistance junction-to-Ambient	$R_{\theta JA}$		62	℃ /W

Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=250μA	80			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=80V,V_{GS}=0V			1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V,V_{DS}=0V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	2.0	3.0	4.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V, I_D=20A		2.8	3.9	mΩ
DYNAMIC PARAMETERS						
C_{lss}	Input Capacitance	V_{DS}=30V,V_{GS}=0V, F=1.0MHz		4500		pF
C_{oss}	Output Capacitance			970		pF
C_{rss}	Reverse Transfer Capacitance			35		pF
SWITCHING PARAMETERS						
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=40V,I_D=1A, V_{GS}=10V, R_G=6Ω		22		nS
t_r	Turn-on Rise Time			16		nS
$t_{d(off)}$	Turn-Off Delay Time			40		nS
t_f	Turn-Off Fall Time			19		nS
Q_g	Total Gate Charge	V_{DS}=40V,I_D=10A, V_{GS}=10V		95		nC
Q_{gs}	Gate-Source Charge			23		nC
Q_{gd}	Gate-Drain Charge			32		nC
V_{SD}	Diode Forward Voltage	V_{GS}=0V,I_{SD}=10A		0.72	1.2	V
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, F=1MHz		1.5		Ω

Note：

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V,V_{GS}=10V,L=0.1mH,IAS=95A., Starting TJ=25℃
3. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
4. Essentially independent of operating temperature.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

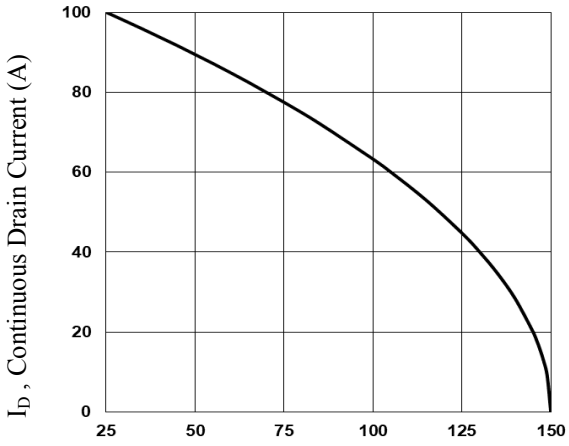


Fig.1 Continuous Drain Current vs. T_C

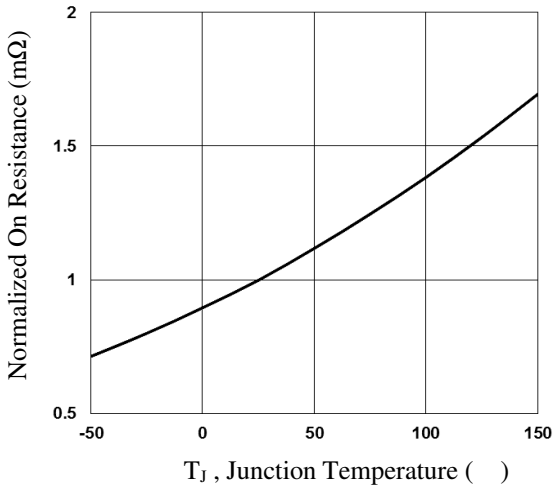


Fig.2 Normalized RDSON vs. T_J

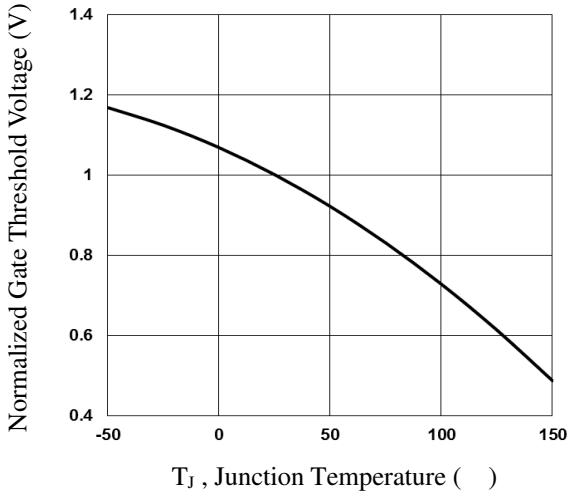


Fig.3 Normalized Vth vs. T_J

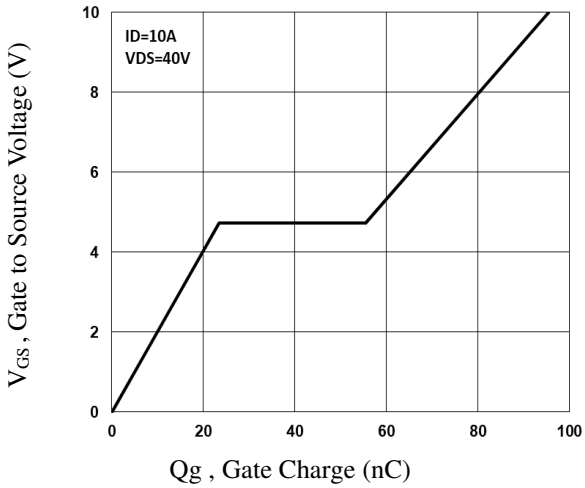


Fig.4 Gate Charge Characteristics

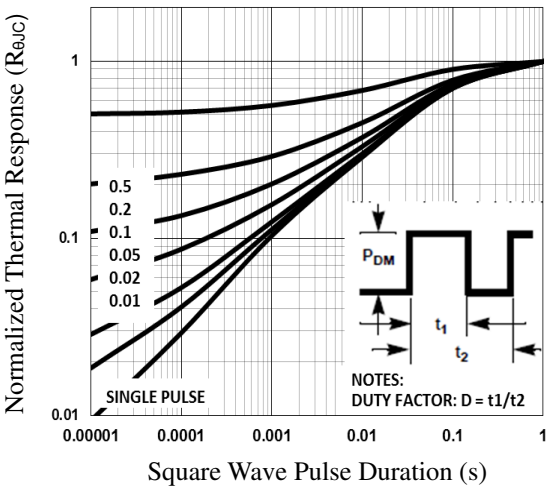


Fig.5 Normalized Transient Impedance

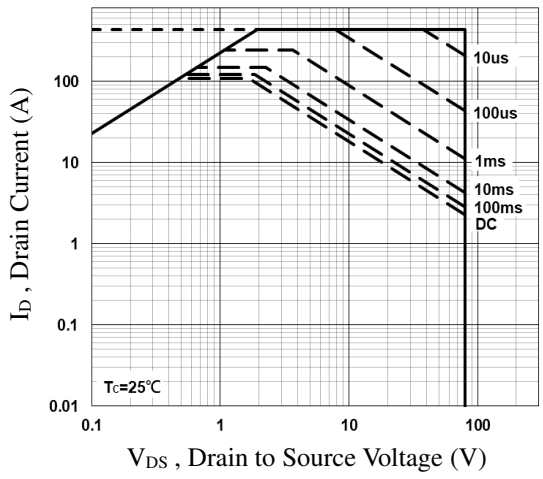


Fig.6 Maximum Safe Operation Area

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

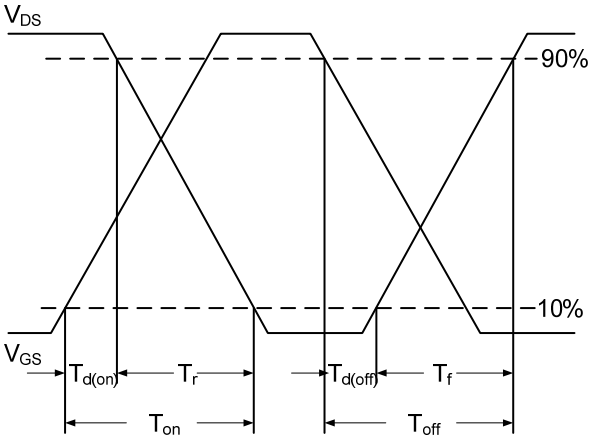


Fig.7 Switching Time Waveform

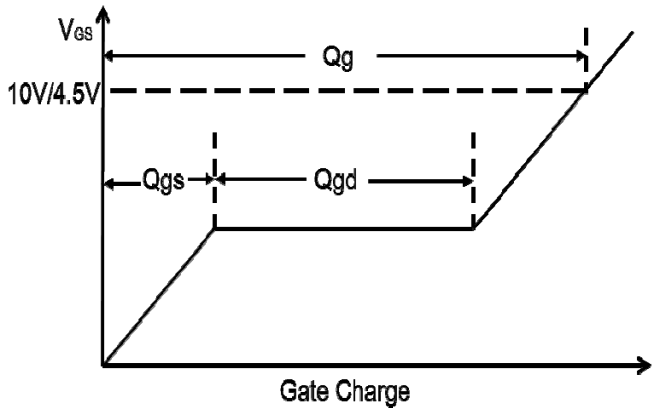
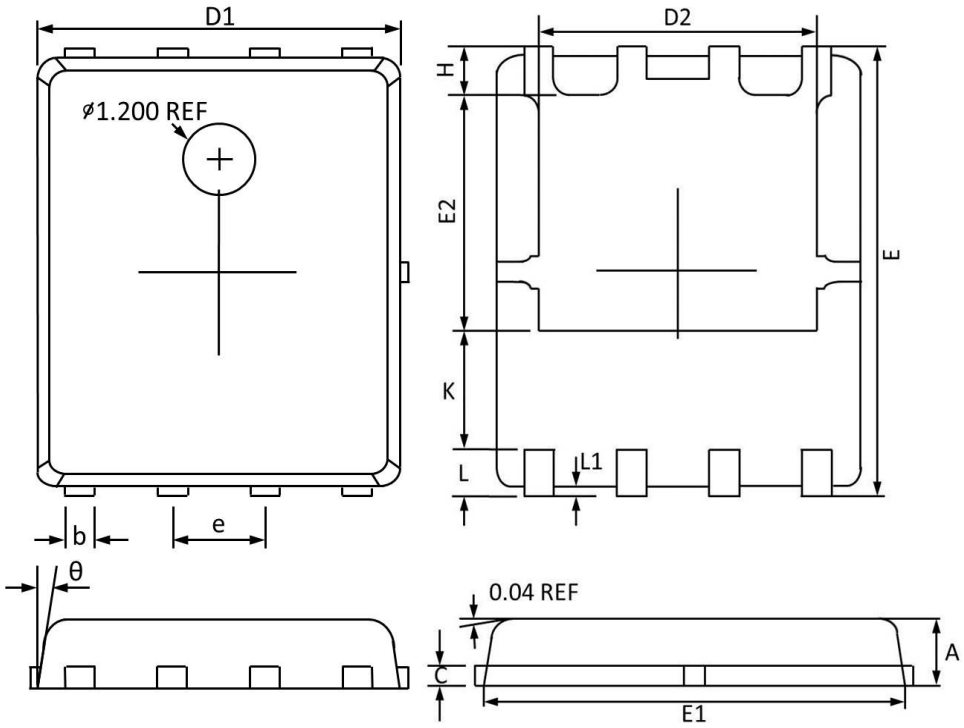


Fig.8 Gate Charge Waveform

DFN5x6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
θ	12°	0°	12°	0°